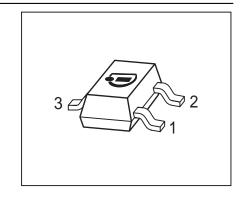


### **NPN Silicon RF Transistor**

- For IF amplifiers in TV-sat tuners and for VCR modulators
- Pb-free (RoHS compliant) package 1)
- Qualified according AEC Q101







ESD (Electrostatic discharge) sensitive device, observe handling precaution!

| Туре   | Marking | Pin Configuration |       |       | Package |
|--------|---------|-------------------|-------|-------|---------|
| BF770A | LSs     | 1 = B             | 2 = E | 3 = C | SOT23   |

**Maximum Ratings** 

| Parameter                             | Symbol             | Value   | Unit |  |
|---------------------------------------|--------------------|---------|------|--|
| Collector-emitter voltage             | $V_{\sf CEO}$      | 12      | V    |  |
| Collector-emitter voltage             | $V_{CES}$          | 20      |      |  |
| Collector-base voltage                | $V_{\mathrm{CBO}}$ | 20      |      |  |
| Emitter-base voltage                  | $V_{EBO}$          | 2       |      |  |
| Collector current                     | I <sub>C</sub>     | 90      | mA   |  |
| Base current                          | I <sub>B</sub>     | 9       |      |  |
| Total power dissipation <sup>2)</sup> | P <sub>tot</sub>   | 300     | mW   |  |
| <i>T</i> <sub>S</sub> ≤ 63°C          |                    |         |      |  |
| Junction temperature                  | $T_{i}$            | 150     | °C   |  |
| Ambient temperature                   | $T_{A}$            | -65 150 |      |  |
| Storage temperature                   | T <sub>stq</sub>   | -65 150 |      |  |

### **Thermal Resistance**

| Parameter                                | Symbol            | Value | Unit |
|--|-------------------|-------|------|
| Junction - soldering point <sup>3)</sup> | R <sub>thJS</sub> | ≤ 290 | K/W  |

<sup>&</sup>lt;sup>1</sup>Pb-containing package may be available upon special request

 $<sup>^2</sup>T_{\mbox{\scriptsize S}}$  is measured on the collector lead at the soldering point to the pcb

 $<sup>^3 \</sup>mbox{For calculation of } R_{\mbox{\scriptsize thJA}}$  please refer to Application Note Thermal Resistance



# **Electrical Characteristics** at $T_A = 25^{\circ}\text{C}$ , unless otherwise specified

| Parameter   | Symbol               | Values |      |      | Unit |
|---|----------------------|--------|------|------|------|
|   |                      | min.   | typ. | max. |      |
| DC Characteristics                                      |                      |        |      |      |      |
| Collector-emitter breakdown voltage                     | V <sub>(BR)CEO</sub> | 12     | -    | -    | ٧    |
| $I_{\rm C} = 1 \text{ mA}, I_{\rm B} = 0$               |                      |        |      |      |      |
| Collector-emitter cutoff current                        | I <sub>CES</sub>     | -      | -    | 100  | μΑ   |
| $V_{CE} = 20 \text{ V}, \ V_{BE} = 0$                   |                      |        |      |      |      |
| Collector-base cutoff current                           | I <sub>CBO</sub>     | -      | -    | 100  | nA   |
| $V_{CB} = 10 \text{ V}, I_{E} = 0$                      |                      |        |      |      |      |
| Emitter-base cutoff current                             | / <sub>EBO</sub>     | -      | -    | 10   | μA   |
| $V_{\rm EB} = 2 \text{ V}, I_{\rm C} = 0$               |                      |        |      |      |      |
| DC current gain-  | h <sub>FE</sub>      | 70     | 100  | 140  | -    |
| $I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, pulse measured |                      |        |      |      |      |



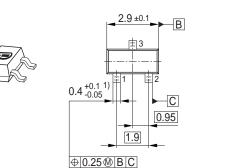
**Electrical Characteristics** at  $T_A = 25$ °C, unless otherwise specified

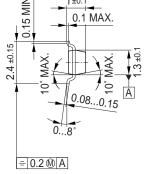
| Parameter  | Symbol                          | Values |      |      | Unit |
|--|---------------------------------|--------|------|------|------|
|  |                                 | min.   | typ. | max. |      |
| AC Characteristics (verified by random samplin                                     | g)                              |        |      |      |      |
| Transition frequency   | $f_{T}$                         | 4.5    | 6    | -    | GHz  |
| $I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, $f$ = 500 MHz                             |                                 |        |      |      |      |
| Collector-base capacitance   | C <sub>cb</sub>                 | -      | 0.54 | 0.75 | pF   |
| $V_{CB} = 10 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$ ,                           |                                 |        |      |      |      |
| emitter grounded   |                                 |        |      |      |      |
| Collector emitter capacitance  | $C_{ce}$                        | -      | 0.25 | -    |      |
| $V_{CE} = 10 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$ ,                           |                                 |        |      |      |      |
| base grounded  |                                 |        |      |      |      |
| Emitter-base capacitance   | C <sub>eb</sub>                 | -      | 1.9  | -    |      |
| $V_{\text{EB}} = 0.5 \text{ V}, f = 1 \text{ MHz}, V_{\text{CB}} = 0$ ,            |                                 |        |      |      |      |
| collector grounded   |                                 |        |      |      |      |
| Noise figure   | F                               |        |      |      | dB   |
| $I_{C} = 5 \text{ mA}, V_{CE} = 8 \text{ V}, Z_{S} = Z_{Sopt},$                    |                                 |        |      |      |      |
| f = 900 MHz  |                                 | -      | 1.5  | -    |      |
| f = 1.8 GHz  |                                 | -      | 2.6  | -    |      |
| Power gain, maximum available <sup>1)</sup>  | G <sub>ma</sub>                 |        |      |      |      |
| $I_{C} = 30 \text{ mA}, V_{CE} = 8 \text{ V}, Z_{S} = Z_{Sopt}, Z_{L} = Z_{Lopt},$ |                                 |        |      |      |      |
| f = 900 MHz  |                                 | -      | 14.5 | -    |      |
| f = 1.8 GHz  |                                 | -      | 9.5  | -    |      |
| Transducer gain  | S <sub>21e</sub>   <sup>2</sup> |        |      |      | dB   |
| $I_{\rm C} = 30$ mA, $V_{\rm CE} = 8$ V, $Z_{\rm S} = Z_{\rm L} = 50\Omega$ ,      |                                 |        |      |      |      |
| f = 900 MHz  |                                 | _      | 12.5 | -    |      |
| f = 1.8 GHz  |                                 | _      | 7    | _    |      |

 $<sup>{}^{1}</sup>G_{ma} = |S_{21}/S_{12}| \ (k-(k^2-1)^{1/2})$ 



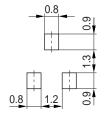
### Package Outline



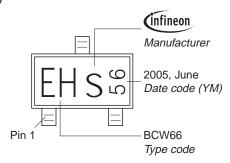


Foot Print

1) Lead width can be 0.6 max. in dambar area

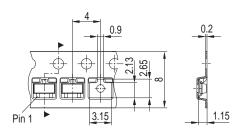


# Marking Layout (Example)



## Standard Packing

Reel Ø180 mm = 3.000 Pieces/Reel Reel Ø330 mm = 10.000 Pieces/Reel





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